A/D 581.40

IAPO3Rec'd PCT 14 FEB 2011

02/18/2011 Form **PTO-1595** (Rev 09/04) OMB No 0651-0027 (exp 6/30/2005)



U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

103618107 12/737779	
	rlease record the aπached documents or the new address(es) below
1. Name of conveying party(ies)/Execution Date(s):	2. Name and address of receiving party(ies)
IKUO TSUKAGOSHI	
	Name SONY CORPORATION
	Internal Address
Execution Date(s) January 14, 2011	Street Address
Additional name(s) of conveying party(ies) attached? Yes X	No 1.7.1 Kenen Minete ku
2 Nature of Commissioners	1-7-1 Konan, Minato-ku Tokyo 108-0075
3. Nature of Conveyance:	JAPAN
X Assignment Merger	
Security Agreement Change of Name	City
Government Interest Assignment	State:
Executive Order 9424, Confirmatory License	Country Z ₁ p
Other	Additional name(s) & address(es) Yes X No
	attached
A Patent Application No (s)	B Patent No (s)
Additional numbers atta	ached? Yes X No
Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name Dennis M. Smid, Esq. LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1 21(h) & 3 41) \$ 40 00
Internal Address Atty Dkt SONYJP 3 3-2306	Authorized to be charged by credit card
Street Address 600 South Avenue West	X Authorized to be charged to deposit account
	Enclosed None required (government interest not affecting title
City Westfield	8. Payment Information
State NJ Zip 07090	a Credit Card Last 4 Numbers
Phone Number (908) 518-6374	Expiration Date
Fax Number (908) 654-0415	b Deposit ABCOLONGO CONTINUELLINS GRANDO 1005 12
Email Address dsmid@idlkm.com	Authorized Leer Name Dennis M. Smid, Esq.
Signature:	
(Lim.su	February 1/1 2011
Signature	Date
Dennis M. Smid, Esq 34,930	Total number of pages including cover
•	_

REEL: 025822 FRAME: 0673

IAPO3Rec'd PCT 14 FEB 2011

PATENT

REEL: 025822 FRAME: 0674

Date of this assignment

Attorney Docket No. SONY Ref. No.: S10P1704US00

ASSIGNMENT

12/737779

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in STEREOSCOPIC IMAGE DATA TRANSMISSION DEVICE, STEREOSCOPIC IMAGE DATA TRANSMISSION METHOD, STEREOSCOPIC IMAGE DATA RECEPTION DEVICE, AND STEREOSCOPIC IMAGE DATA RECEPTION METHOD for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: PCT/JP2010/060588 Filing Date: June 22, 2010 This assignment executed on the dates indicated below. IKUO TSUKAGOSHI Name of first or sole inventor Execution date of U.S. Patent Application TOKYO JAPAN Residence of First or sole inventor Signature of first or sole inventor Name of second inventor Execution date of U.S. Patent Application Residence of second inventor Signature of second inventor Date of this assignment Name of third inventor Execution date of U.S. Patent Application Residence of third inventor

Signature of third inventor

RECORDED: 02/14/2011